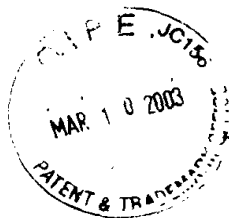


Fig. 2



TITLE: INTEGRATED CIRCUIT PACKAGE ALIGNMENT
FEATURE

Inventor: David J. Corisis et al.

Serial No.: 09/819,874

Docket No.: 3770.3US

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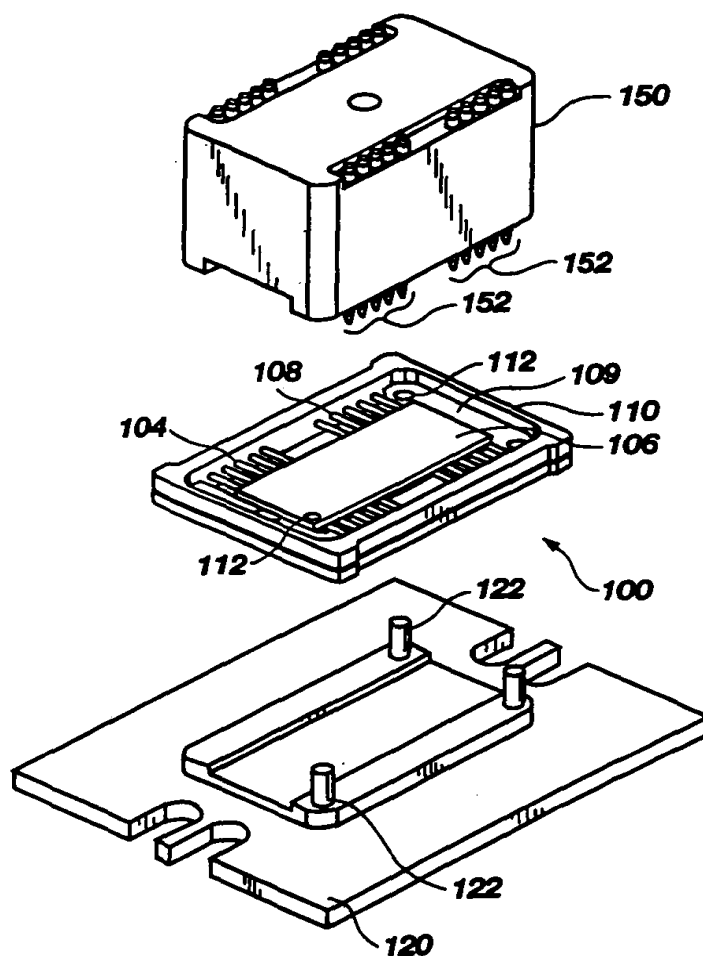
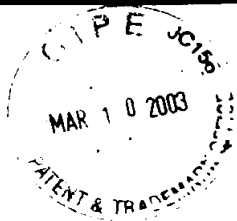


Fig. 1
(PRIOR ART)



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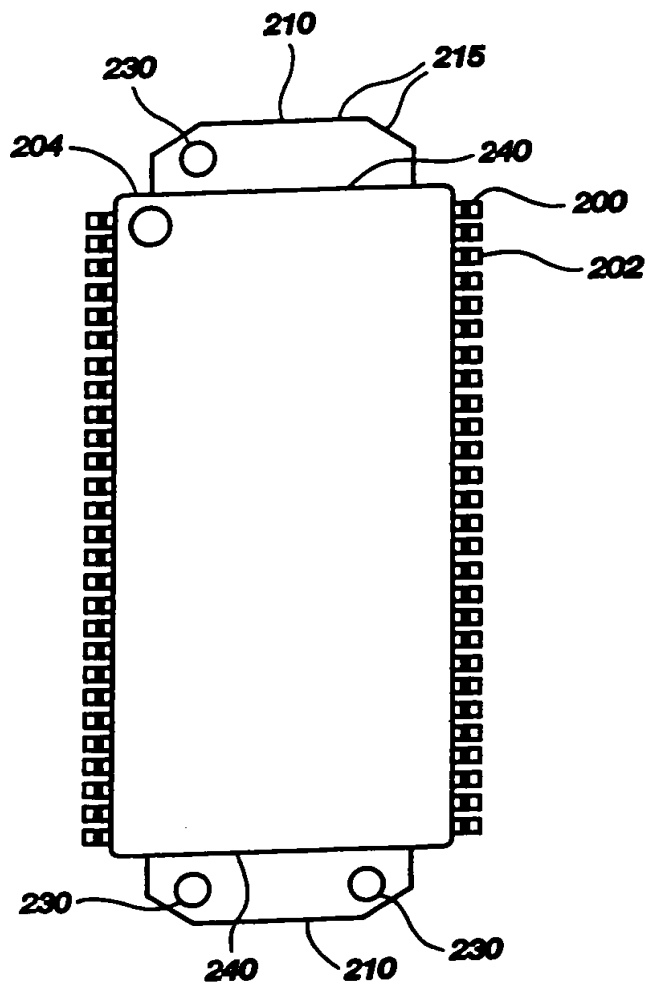


Fig. 2



TITLE: INTEGRATED CIRCUIT PACKAGE FEATURE
Inventor: David J. Corisis et al.
Serial No.: 09/819,874
Docket No.: 3770.3US

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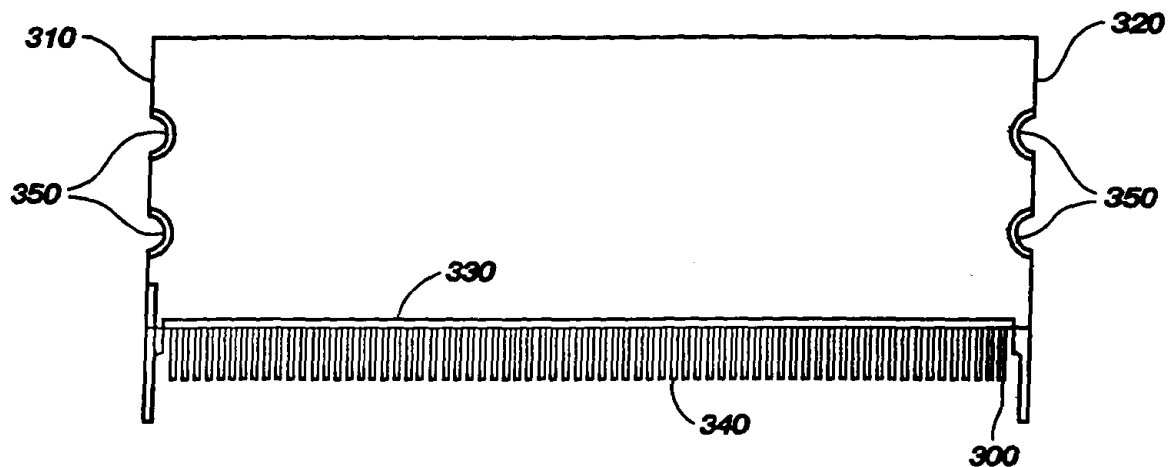
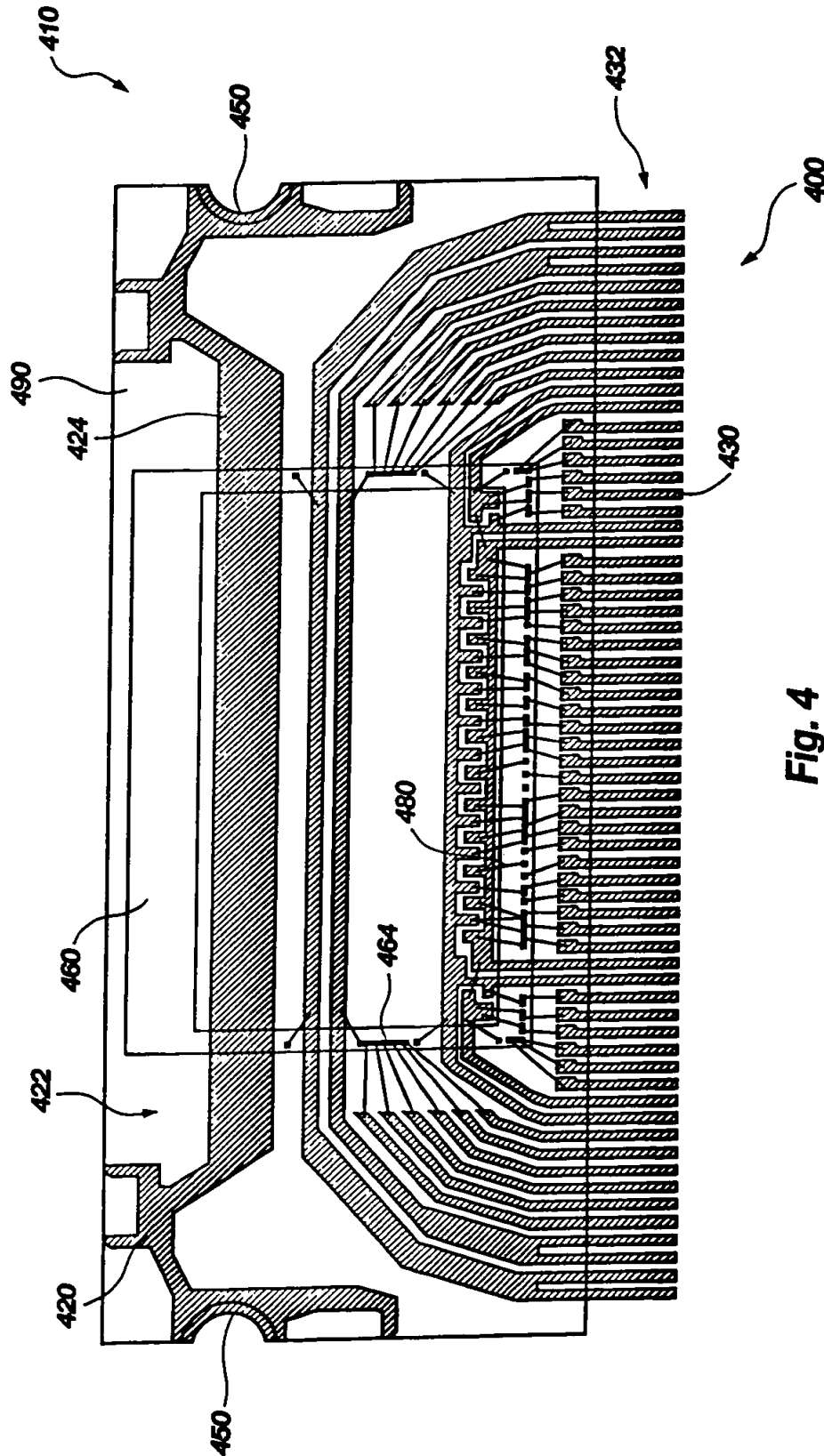


Fig. 3

Fig. 4



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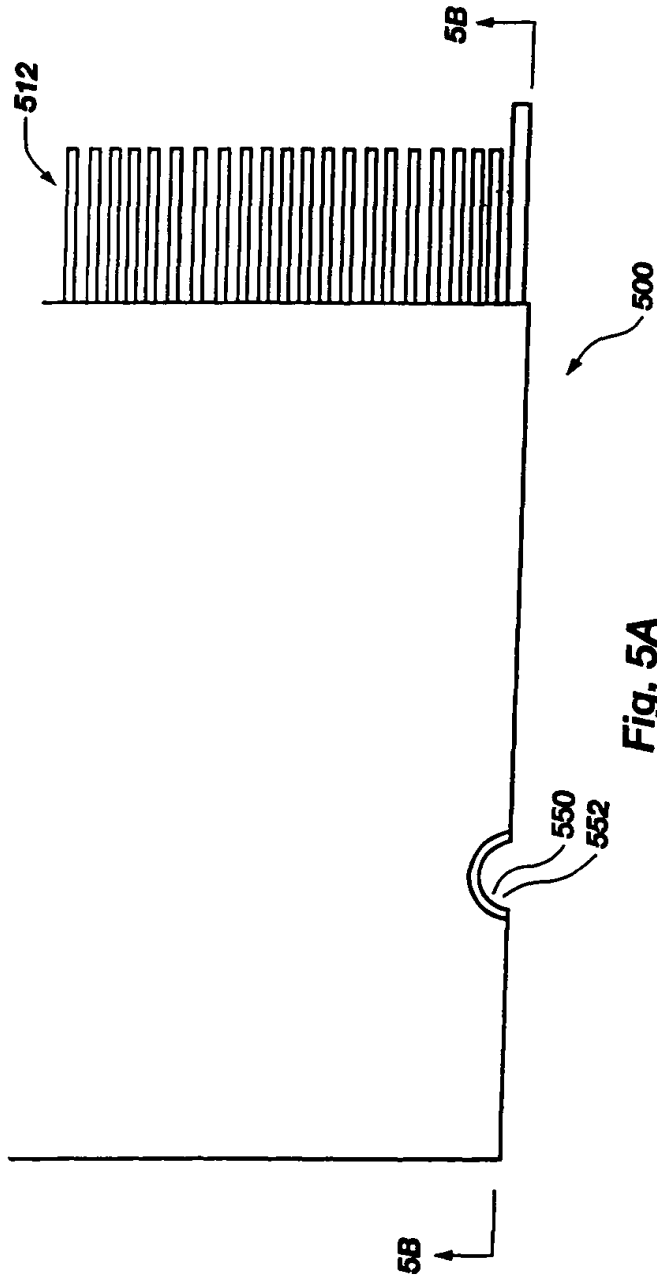


Fig. 5A

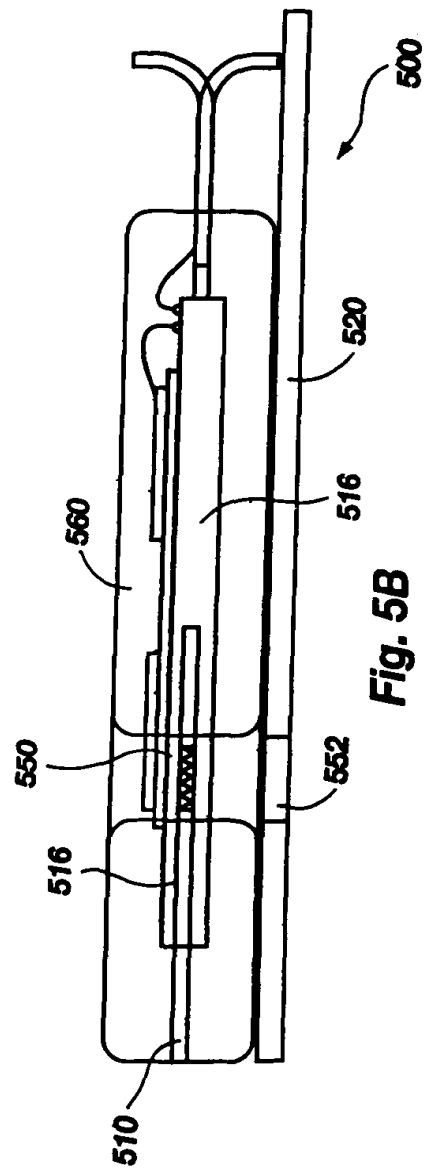


Fig. 5B

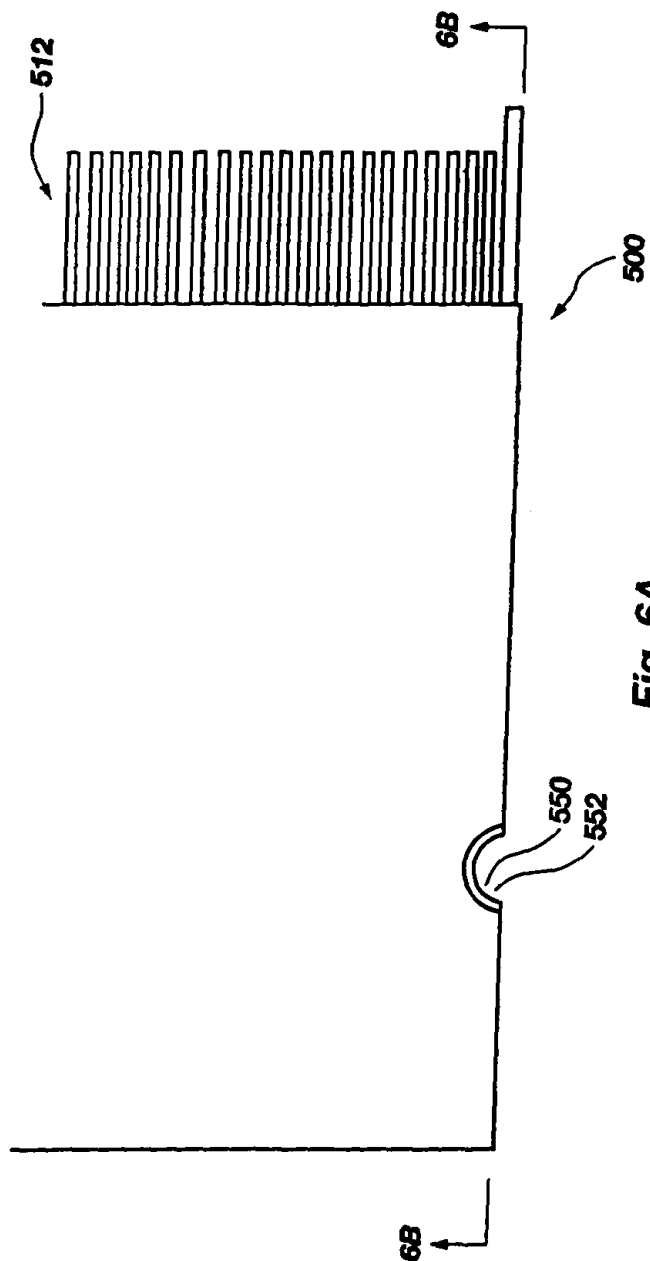


Fig. 6A

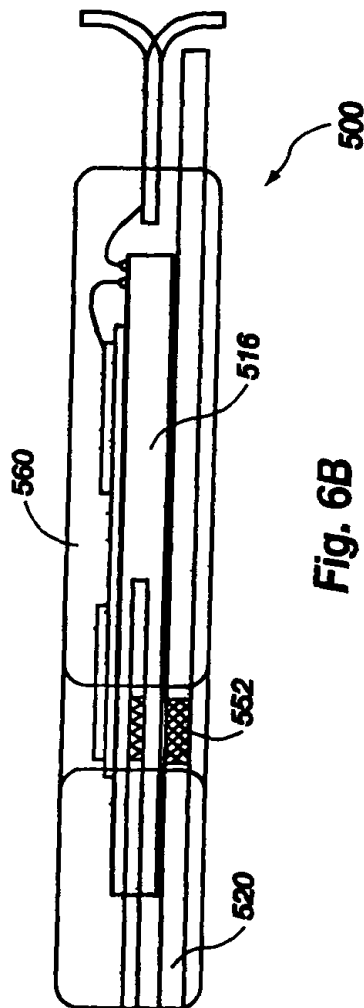


Fig. 6B

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TITLE: INTEGRATED CIRCUIT PACKAGE FEATURE

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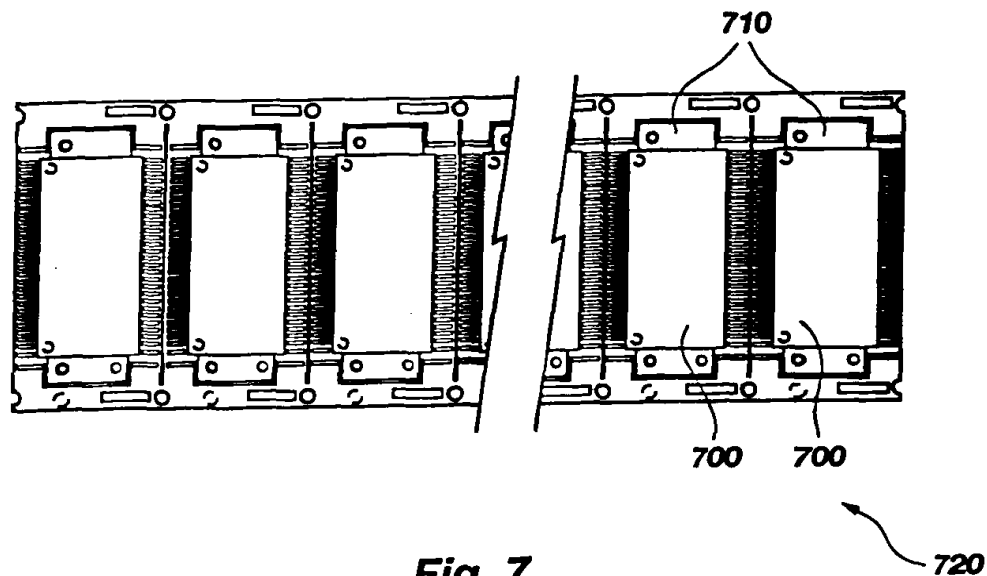


Fig. 7

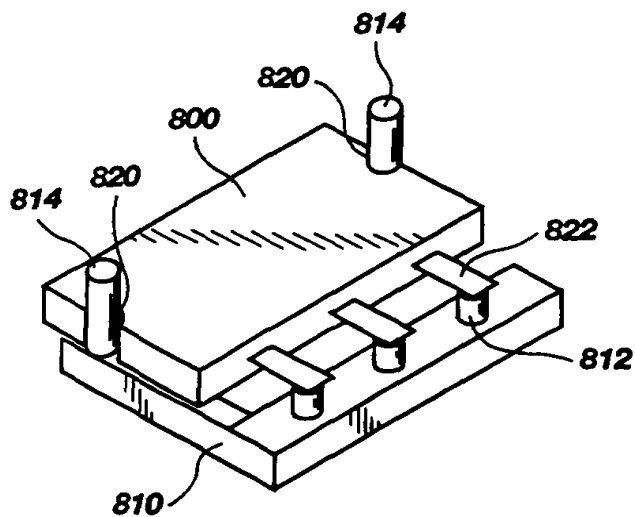


Fig. 8